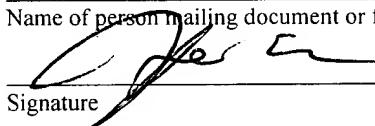


IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Box Non-Fee Amendment
Commissioner for Patents
Washington, D.C. 20231

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to Box Non-Fee Amendment, Commissioner for Patents Washington, D.C. 20231 on April 7, 2003
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Harold C. Moore
Name of person mailing document or fee


Signature

April 7, 2003
Date of Signature

Response
Communication
4/16/03
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APR 15 2003
TECHNOLOGY CENTER 2800

Re: Application of: Newell E. Chiesl
Serial No.: 09/960,441
Filed: September 21, 2001
Confirmation No.: 5776
For: Arrangement for Measuring Pressure on a
Semiconductor Wafer and an Associated
Method for Fabricating a Semiconductor
Wafer
Group Art Unit: 2812
Examiner: Viktor Simkovic
Our Docket: 1003-0610 (01-384)

RESPONSE TO NOTICE OF NON-COMPLIANT AMENDMENT

Sir:

In response to the Notice of Non-Compliant Amendment dated March 5, 2003 for the above-identified patent application, please amend the application as follows: